						-				
					Application Number		09/844,293			
RE JC,				Filing Date		April 26, 2001				
			First Named Inventor		Bothra, Subhas					
AL THE	(姓) e used for all co	nitial filing)	Art Unit		2826					
			Examiner Name		Alexander O. Williams					
PATENT &	Total Number of Page Submission	Total Number of Pages in This Submission		Attorney Docket Number		020408-001200US				
	ENCLOSURES (Check all that apply)									
•	Fee Transmittal	Form	☑ Drawin	g(s)		After Allowance Communication to Group				
•	Fee Attached		Licensing-related Papers		Appeal Communication to Board of Appeals and Interferences					
	Amendment/Reply		Petition			Appeal Communication to Group (Appeal Notice, Brief, Reply Brief)				
:	After Final		Petition to Convert to a Provisional Application			Proprietary Information				
-	Affidavits/declaration(s)		Power of Attorney, Revocation Change of Correspondence Address		Status Letter					
•	Extension of Time Request		Terminal Disclaimer		Other Enclosure(s) (please identify below):					
•	Express Abandonment Request		☐ Request for Refund ☐ CD, Number of CD(s)			PTO-85B Issue Fee Transmittal Letter to Official Draftsperson Return Postcard				
2	☐ Information Disclosure Statement									
•	Certified Copy of Priority Document(s)		The Commissioner is a Account 20-1430.		authorized to	charge any	additional fees to Deposit			
	Response to Missing Parts/ Incomplete Application		· .							
t to	Response to Missing Parts under 37 CFR 1.52 or 1.53		•							
•	SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT Firm Townsend and Townsend and Crew LLP									
. *										
	or Individual Chun-Pok Leung Reg. No. 41,405									
•	Signature	1	01	CLOU						
	Date (2 – (8 – 5)									
	CERTIFICATE OF TRANSMISSION/MAILING									
\$ • •	I hereby certify that this correspondence is being facsimile transmitted to the USPTO or deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on the date shown below.									
	Typed or printed name Andrea S/Beck									
	Signature					Date	12			

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I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to:

Attorney Docket No.: 020408-001200US

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Mail Stop Issue Fee Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

on December 10, 2003

TOWNSEND and TOWNSEND and CREW LLP

Andrea S. Beck

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Subhas Bothra, et al.

Application No.: 09/844,293

Filed: April 26, 2001

For: Structure to Increase Density of

MIM Capacitors Between Adjacent

Metal Layers in a Integrated

Circuit

Confirmation No: 1043

Examiner: Alexander O. Williams

Art Unit: 2826

LETTER TO OFFICIAL DRAFTSPERSON

Mail Stop Issue Fee Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In response to the Notice of Allowance dated October 3, 2003, applicants hereby submit 7 sheets of formal drawings to be made of record in the above-identified case.

Respectfully submitted,

Chun-Pok Leung Reg. No. 41,405

TOWNSEND and TOWNSEND and CREW LLP Two Embarcadero Center, 8th Floor San Francisco, CA 94111 (650) 326-2400 Fax (650) 326-2422